

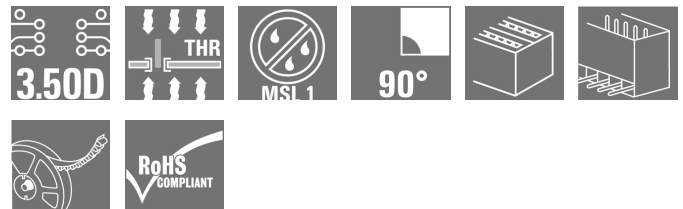
S2C-SMT 3.50/10/90G 1.5SN BK RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

Similar to illustration

High-temperature-resistant male header

- Finger-safe
- Can be plugged into female plug B2CF 3.50 PUSH IN
- **Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)**
- Housing variants: closed (G) and with solder flange (LF)
- **Packed either in a box (BX) or on anti-static tape-on-reel (RL)**
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.2 mm

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 10, 90°, Solder pin length (l): 1.5 mm, tinned, black, Tape
Order No.	1359610000
Type	S2C-SMT 3.50/10/90G 1.5SN BK RL
GTIN (EAN)	4050118162967
Qty.	235 pc(s).
Product data	IEC: 200 V / 13.4 A UL: 150 V / 10 A
Packaging	Tape

Creation date September 16, 2022 4:40:05 AM CEST

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Technical data**Dimensions and weights**

Depth	14.2 mm	Depth (inches)	0.559 inch
Height	12.3 mm	Height (inches)	0.484 inch
Height of lowest version	10.8 mm	Width	18.9 mm
Width (inches)	0.744 inch	Net weight	2.827 g

System specifications

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	10	Number of solder pins per pole	1
Solder pin length (l)	1.5 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D) + 0,1 mm	
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	14 mm	L1 in inches	0.551 inch
Number of rows	1	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	touch-safe on connector face, safe to back of hand above the printed circuit board	Touch-safe protection acc. to DIN VDE 0470	
Can be coded	Yes		IP 20
Pulling force/pole, max.	2.5 N	Plugging force/pole, max.	3.5 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...5 µm Sn matt
Layer structure of plug contact	2...5 µm Sn / 1...3 µm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	13.4 A
Rated current, min. number of poles (Tu=40°C)	12 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	80 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

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Technical data**Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA) 150 V

Rated voltage (Use group C / CSA) 50 V

Rated voltage (Use group D / CSA) 150 V

Rated current (Use group B / CSA) 9.5 A

Rated current (Use group C / CSA) 9.5 A

Rated current (Use group D / CSA) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

Packaging Tape

VPE length 330 mm

VPE width 330 mm

VPE height 50 mm

Tape depth (T2) 15.1 mm

Tape width (W) 44 mm

Tape pocket depth (K0) 14.6 mm

Tape pocket height (A0) 14.5 mm

Tape pocket width (B0) 32.9 mm

Tape pocket separation (P1) 20 mm

Tape hole separation (E) 1.75 mm

Tape pocket separation (F) 20.2 mm

Tape reel diameter Ø (A) 330 mm

Surface resistance $R_s = 10^9 - 10^{12} \Omega$ **Classifications**

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ETIM 8.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 12.0 27-46-02-01

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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www.weidmueller.com**Technical data****Approvals**

Approvals



ROHS Conform

UL File Number Search UL Website

Certificate No. (cURus) E60693

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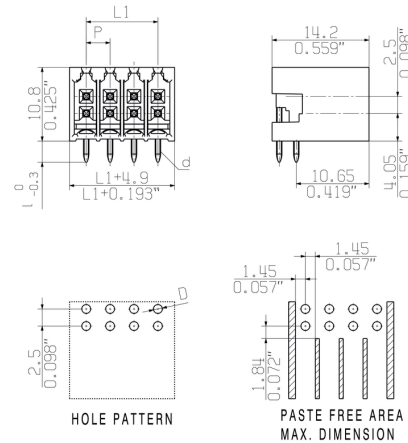
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Drawings

Dimensional drawing



Product benefits

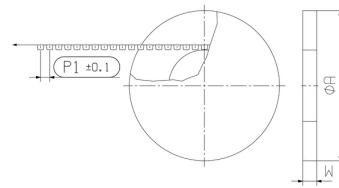


Optimised for the SMT process
Safe board-to-board connection

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Drawings
Dimensional drawing

Dimensional drawing


Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.